

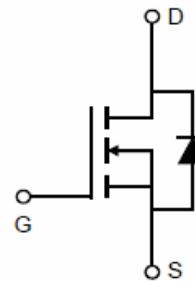
## N-Channel Enhancement Mode Power MOSFET

### Description

The RM50N60DF uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

### General Features

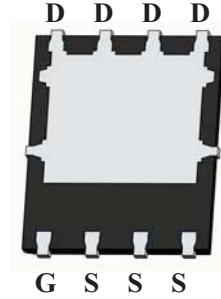
- $V_{DS} = 60V, I_D = 50A$
- $R_{DS(ON)} < 16m\Omega @ V_{GS}=10V$
- $R_{DS(ON)} < 18m\Omega @ V_{GS}=4.5V$
- High density cell design for ultra low  $R_{DS(on)}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high  $E_{AS}$
- Excellent package for good heat dissipation



Schematic Diagram



Top View



Bottom View

### Application

- PWM
- Load Switching
- P/N suffix V means AEC-Q101 qualified, e.g.:RM50N60DFV
- Halogen-free

**100% UIS TESTED!**

**100%  $\Delta V_{ds}$  TESTED!**

### Package Marking and Ordering Information

| Device Marking | Device    | Device Package | Reel Size | Tape width | Quantity |
|----------------|-----------|----------------|-----------|------------|----------|
| 50N60          | RM50N60DF | DFN5X6-8L      | -         | -          | -        |

### Absolute Maximum Ratings ( $T_c=25^\circ C$ unless otherwise noted)

| Parameter                                        | Symbol              | Limit      | Unit          |
|--------------------------------------------------|---------------------|------------|---------------|
| Drain-Source Voltage                             | $V_{DS}$            | 60         | V             |
| Gate-Source Voltage                              | $V_{GS}$            | $\pm 20$   | V             |
| Drain Current-Continuous                         | $I_D$               | 50         | A             |
| Drain Current-Continuous( $T_c=100^\circ C$ )    | $I_D (100^\circ C)$ | 33         | A             |
| Pulsed Drain Current                             | $I_{DM}$            | 120        | A             |
| Maximum Power Dissipation                        | $P_D$               | 104        | W             |
| Derating factor                                  |                     | 0.6        | W/ $^\circ C$ |
| Single pulse avalanche energy (Note 5)           | $E_{AS}$            | 390        | mJ            |
| Operating Junction and Storage Temperature Range | $T_J, T_{STG}$      | -55 To 150 | $^\circ C$    |

### Thermal Characteristic

|                                                          |           |     |              |
|----------------------------------------------------------|-----------|-----|--------------|
| Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup> | $R_{eJC}$ | 1.2 | $^\circ C/W$ |
|----------------------------------------------------------|-----------|-----|--------------|

## Electrical Characteristics ( $T_c=25^\circ\text{C}$ unless otherwise noted)

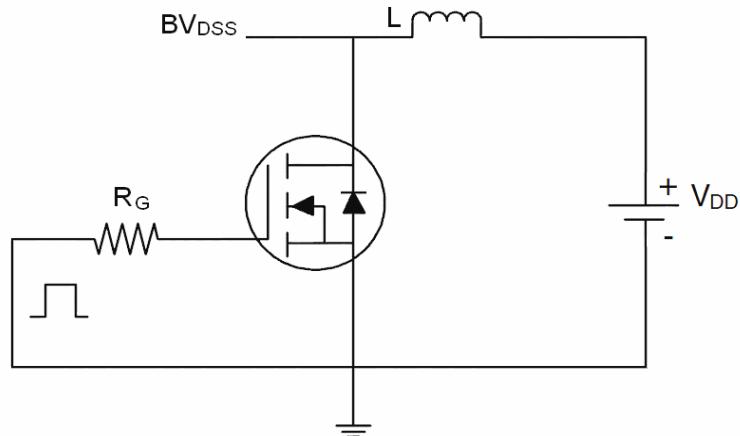
| Parameter                                 | Symbol                   | Condition                                                                                                  | Min | Typ  | Max       | Unit             |
|-------------------------------------------|--------------------------|------------------------------------------------------------------------------------------------------------|-----|------|-----------|------------------|
| <b>Off Characteristics</b>                |                          |                                                                                                            |     |      |           |                  |
| Drain-Source Breakdown Voltage            | $\text{BV}_{\text{DSS}}$ | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$                                                     | 60  | -    | -         | V                |
| Zero Gate Voltage Drain Current           | $I_{\text{DSS}}$         | $V_{\text{DS}}=60\text{V}, V_{\text{GS}}=0\text{V}$                                                        | -   | -    | 10        | $\mu\text{A}$    |
| Gate-Body Leakage Current                 | $I_{\text{GSS}}$         | $V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$                                                    | -   | -    | $\pm 100$ | nA               |
| <b>On Characteristics</b> (Note 3)        |                          |                                                                                                            |     |      |           |                  |
| Gate Threshold Voltage                    | $V_{\text{GS(th)}}$      | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$                                                 | 1.0 | -    | 3.0       | V                |
| Drain-Source On-State Resistance          | $R_{\text{DS(ON)}}$      | $V_{\text{GS}}=10\text{V}, I_{\text{D}}=25\text{A}$                                                        | -   | 14   | 16        | $\text{m}\Omega$ |
|                                           |                          | $V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=15\text{A}$                                                       | -   | -    | 18        | $\text{m}\Omega$ |
| Forward Transconductance                  | $g_{\text{FS}}$          | $V_{\text{DS}}=10\text{V}, I_{\text{D}}=30\text{A}$                                                        | -   | 71   | -         | S                |
| <b>Dynamic Characteristics</b> (Note 4)   |                          |                                                                                                            |     |      |           |                  |
| Input Capacitance                         | $C_{\text{iss}}$         | $V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}, F=1.0\text{MHz}$                                       | -   | 1920 | 2300      | pF               |
| Output Capacitance                        | $C_{\text{oss}}$         |                                                                                                            | -   | 185  | -         | pF               |
| Reverse Transfer Capacitance              | $C_{\text{rss}}$         |                                                                                                            | -   | 80   | -         | pF               |
| <b>Switching Characteristics</b> (Note 4) |                          |                                                                                                            |     |      |           |                  |
| Turn-on Delay Time                        | $t_{\text{d(on)}}$       | $V_{\text{DS}}=30\text{V}, I_{\text{D}}=20\text{A}, V_{\text{GS}}=10\text{V}, R_{\text{G}}=3.3\Omega$      | -   | 10   | -         | nS               |
| Turn-on Rise Time                         | $t_r$                    |                                                                                                            | -   | 43   | -         | nS               |
| Turn-Off Delay Time                       | $t_{\text{d(off)}}$      |                                                                                                            | -   | 47   | -         | nS               |
| Turn-Off Fall Time                        | $t_f$                    |                                                                                                            | -   | 80   | -         | nS               |
| Total Gate Charge                         | $Q_g$                    | $V_{\text{DS}}=48\text{V}, I_{\text{D}}=20\text{A}, V_{\text{GS}}=4.5\text{V}$                             | -   | 33   | 45        | nC               |
| Gate-Source Charge                        | $Q_{\text{gs}}$          |                                                                                                            | -   | 5    | -         | nC               |
| Gate-Drain Charge                         | $Q_{\text{gd}}$          |                                                                                                            | -   | 21   | -         | nC               |
| <b>Drain-Source Diode Characteristics</b> |                          |                                                                                                            |     |      |           |                  |
| Diode Forward Voltage (Note 3)            | $V_{\text{SD}}$          | $V_{\text{GS}}=0\text{V}, I_{\text{S}}=20\text{A}$                                                         | -   | -    | 1.3       | V                |
| Diode Forward Current (Note 2)            | $I_{\text{S}}$           |                                                                                                            | -   | -    | 80        | A                |
| Reverse Recovery Time                     | $t_{\text{rr}}$          | $T_{\text{J}} = 25^\circ\text{C}, I_{\text{S}} = 10\text{A}$<br>$dI/dt = 100\text{A}/\mu\text{s}$ (Note 3) | -   | 30   | -         | nS               |
| Reverse Recovery Charge                   | $Q_{\text{rr}}$          |                                                                                                            | -   | 18   | -         | nC               |

### Notes:

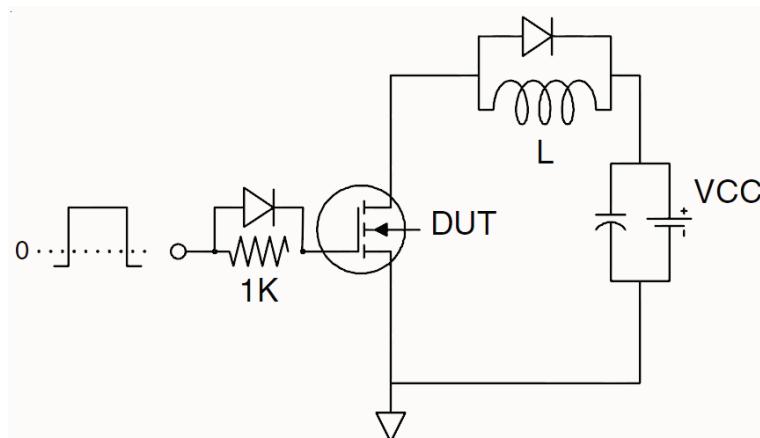
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production
5. E<sub>AS</sub> condition :  $T_j=25^\circ\text{C}, V_{\text{DD}}=30\text{V}, V_{\text{G}}=10\text{V}, L=0.5\text{mH}, R_g=25\Omega$

## Test circuit

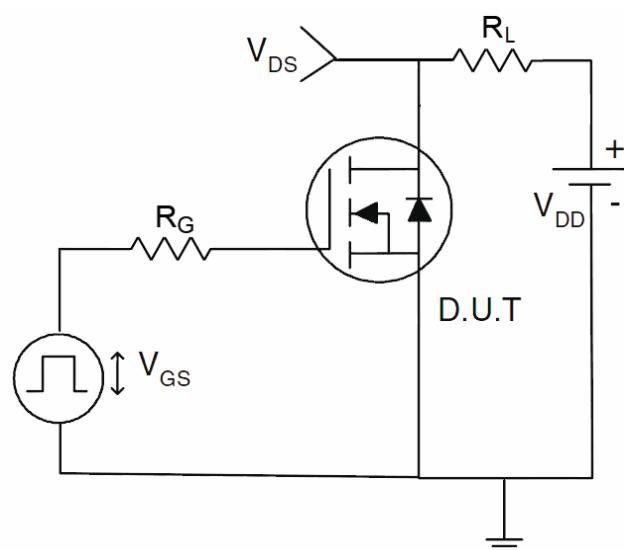
### 1) E<sub>AS</sub> Test Circuit



### 2) Gate Charge Test Circuit



### 3) Switch Time Test Circuit



## RATING AND CHARACTERISTICS CURVES ( RM50N60DF)

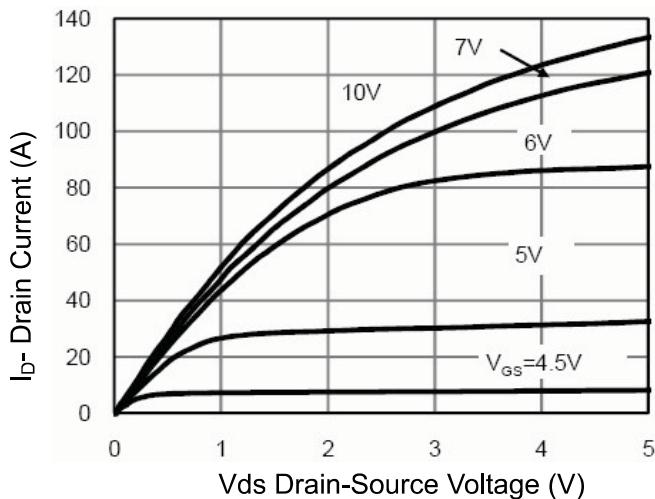


Figure 1 Output Characteristics

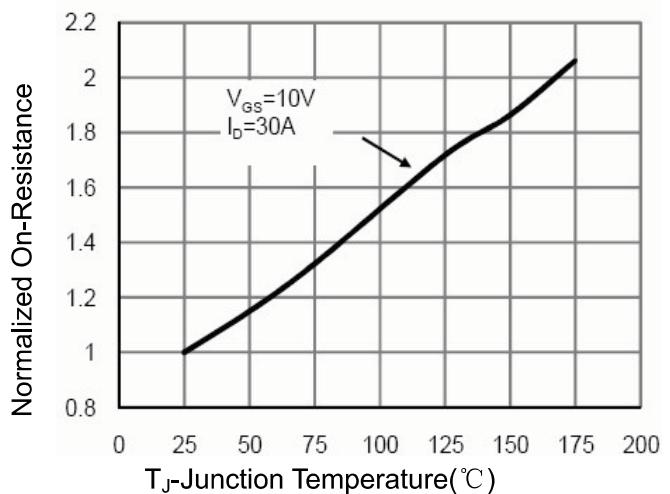


Figure 4 Rdson-JunctionTemperature

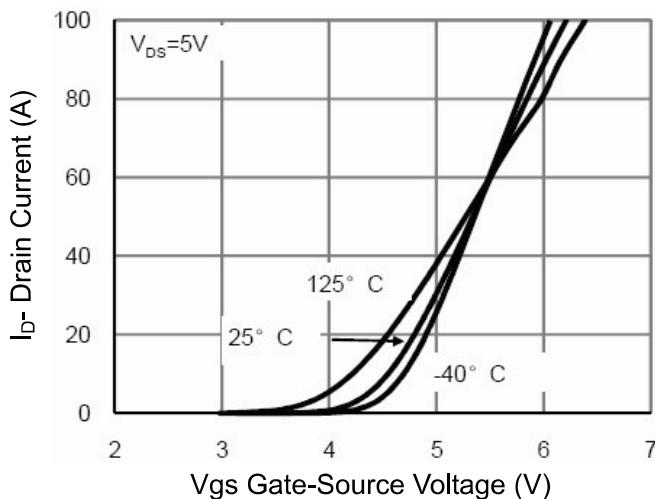


Figure 2 Transfer Characteristics

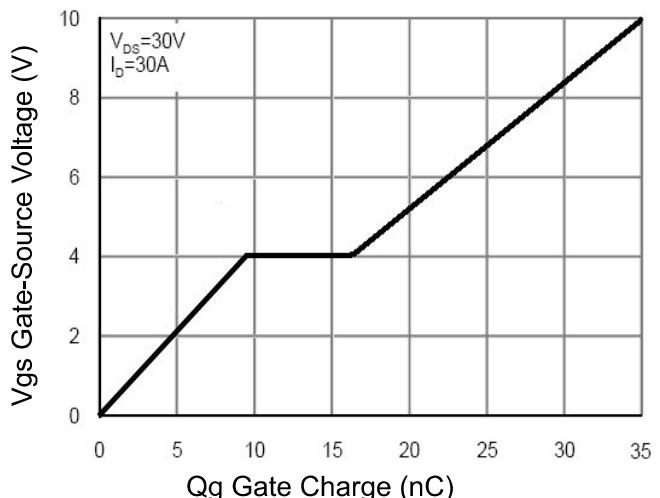


Figure 5 Gate Charge

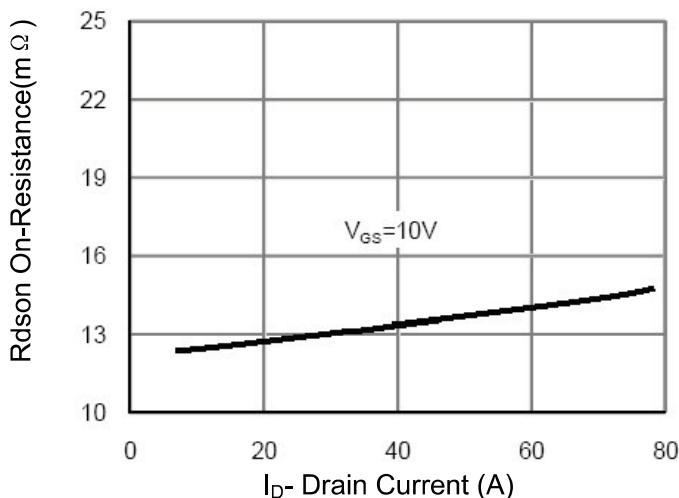


Figure 3 Rdson- Drain Current

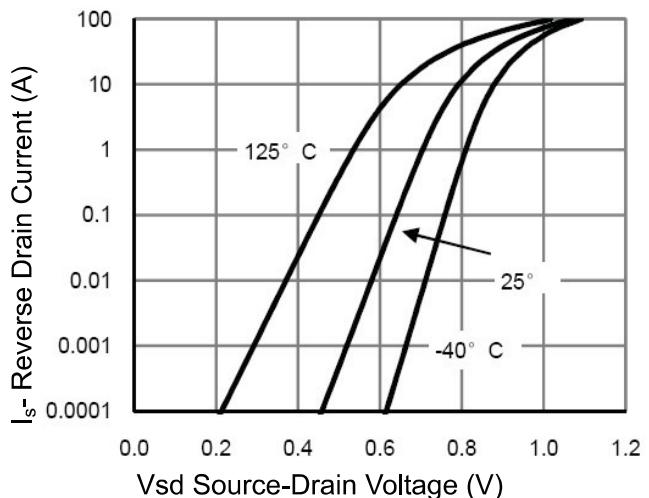
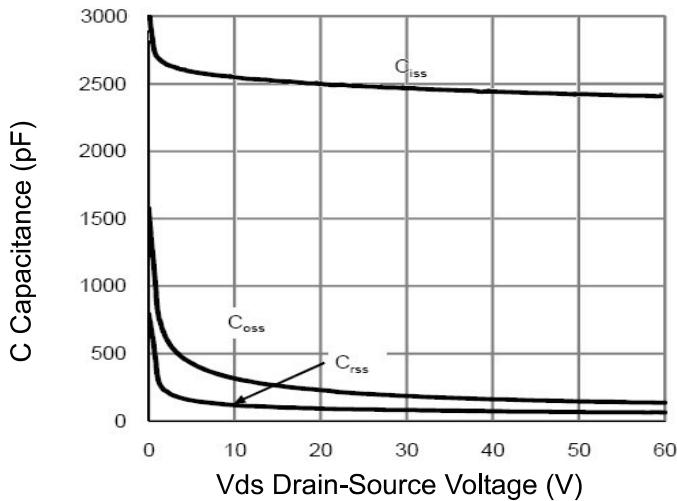
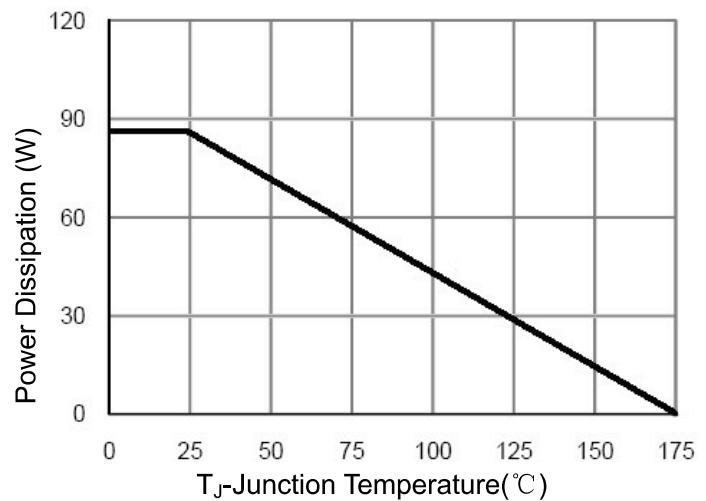


Figure 6 Source- Drain Diode Forward

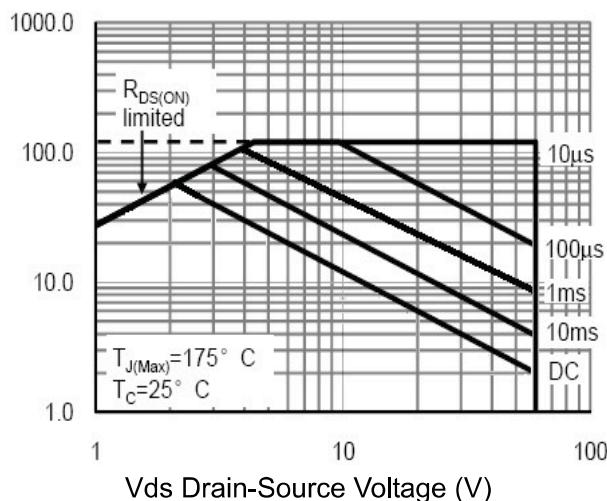
## RATING AND CHARACTERISTICS CURVES ( RM50N60DF)



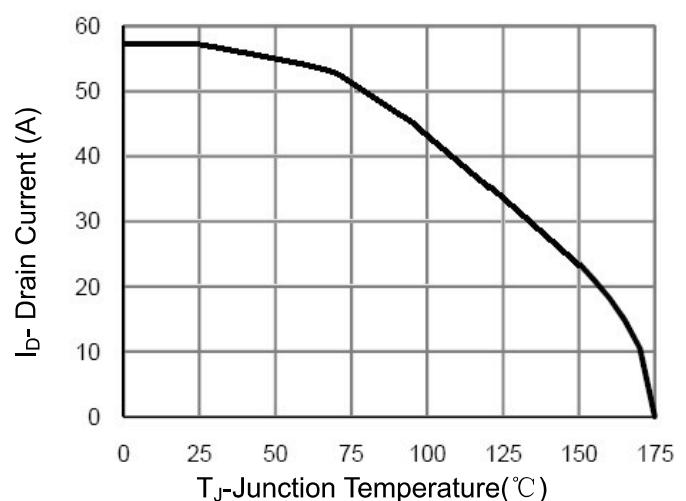
**Figure 7 Capacitance vs Vds**



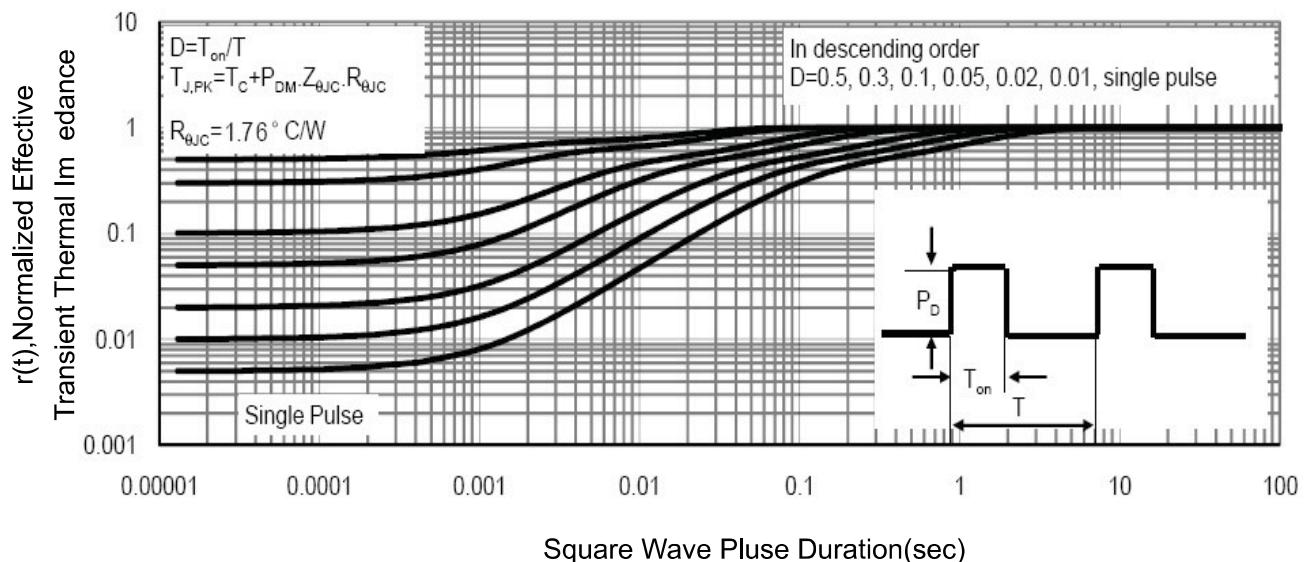
**Figure 9 Power De-rating**



**Figure 8 Safe Operation Area**

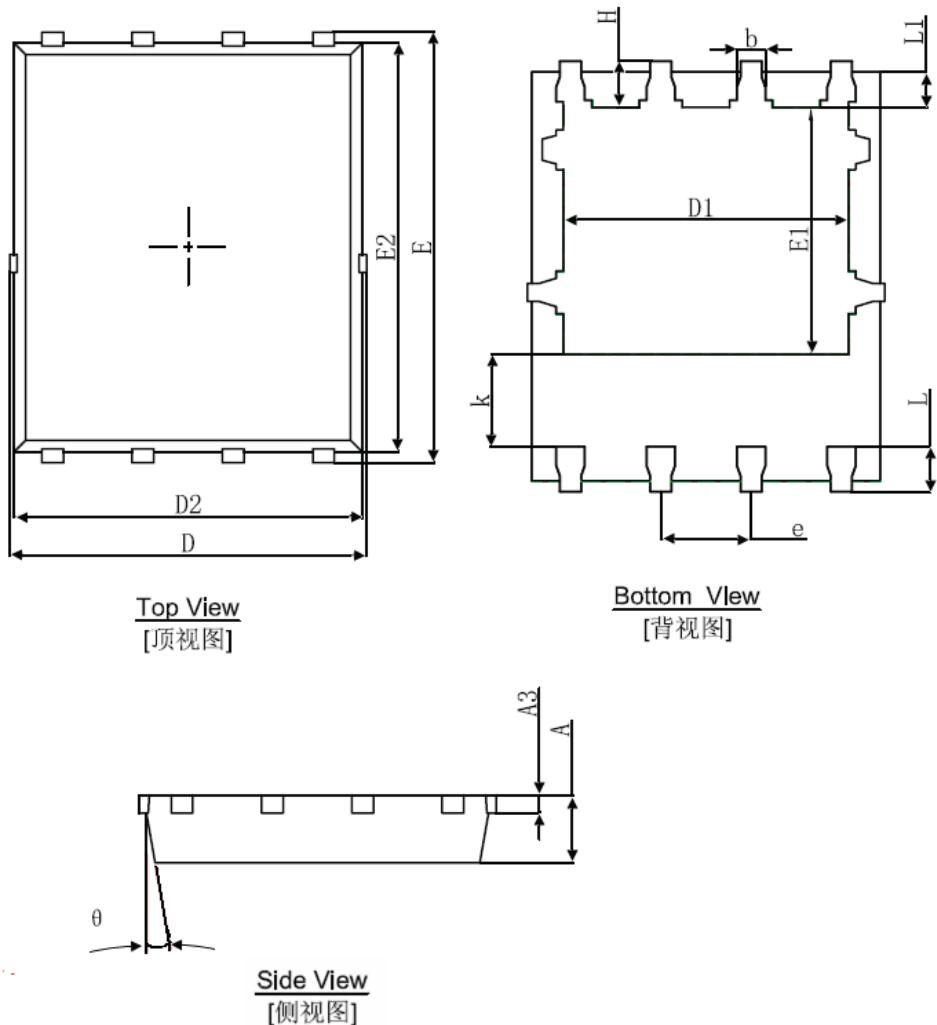


**Figure 10 ID Current- JunctionTemperature**



**Figure 11 Normalized Maximum Transient Thermal Impedance**

## DFN5X6-8L Package Information



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min.                      | Max.  | Min.                 | Max.  |
| A      | 0.900                     | 1.000 | 0.035                | 0.039 |
| A3     | 0.254REF.                 |       | 0.010REF.            |       |
| D      | 4.944                     | 5.096 | 0.195                | 0.201 |
| E      | 5.974                     | 6.126 | 0.235                | 0.241 |
| D1     | 3.910                     | 4.110 | 0.154                | 0.162 |
| E1     | 3.375                     | 3.575 | 0.133                | 0.141 |
| D2     | 4.824                     | 4.976 | 0.190                | 0.196 |
| E2     | 5.674                     | 5.826 | 0.223                | 0.229 |
| k      | 1.190                     | 1.390 | 0.047                | 0.055 |
| b      | 0.350                     | 0.450 | 0.014                | 0.018 |
| e      | 1.270TYP.                 |       | 0.050TYP.            |       |
| L      | 0.559                     | 0.711 | 0.022                | 0.028 |
| L1     | 0.424                     | 0.576 | 0.017                | 0.023 |
| H      | 0.574                     | 0.726 | 0.023                | 0.029 |
| θ      | 8°                        | 12°   | 8°                   | 12°   |

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